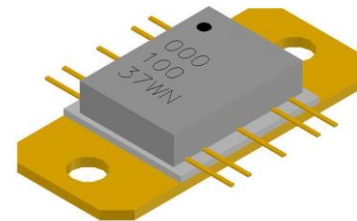


## DESCRIPTION

AMCOM's AM00010037WN-SN-R is a broadband GaN MMIC power amplifier. It has 13dB gain, and 37 dBm output power over the DC to 10GHz band. The AM00010037WN-SN-R is in a ceramic package with a flange and straight RF and DC leads for drop-in assembly. Because of high DC power dissipation, good heat sinking is required. The package is RoHS compliant. This MMIC is matched to 50 Ohms.



## FEATURES

- Ultra-Broadband from DC to 10GHz
- Saturated output power  $P_{sat}$  is 37dBm
- Gain, 13dB
- Input & output matched to 50 Ohms

## APPLICATIONS

- Instrumentation
- Commercial telecom transmission equipment
- Fixed microwave backhaul

## TYPICAL PERFORMANCE \* (Recommended bias condition)

**Bias Conditions\*\*:**  $V_{ds} = 28V$ ,  $I_{ds} = 300mA$ ,  $V_{gs} = -2V$

Parameters	Minimum	Typical **	Maximum
Frequency	0.1 – 10 GHz	DC – 10 GHz	
Small Signal Gain	10dB	13dB	
Gain Ripple		$\pm 1.5dB$	$\pm 3.0dB$
P1dB	-	30dBm	
P5dB	35dBm	37dBm	
P5dB PAE		22%	
P5dB Drain Efficiency		25%	
NF (1-9 GHz)		5	
Input Return Loss		9dB	
Output Return Loss		7dB	
Thermal Resistance		TBD	

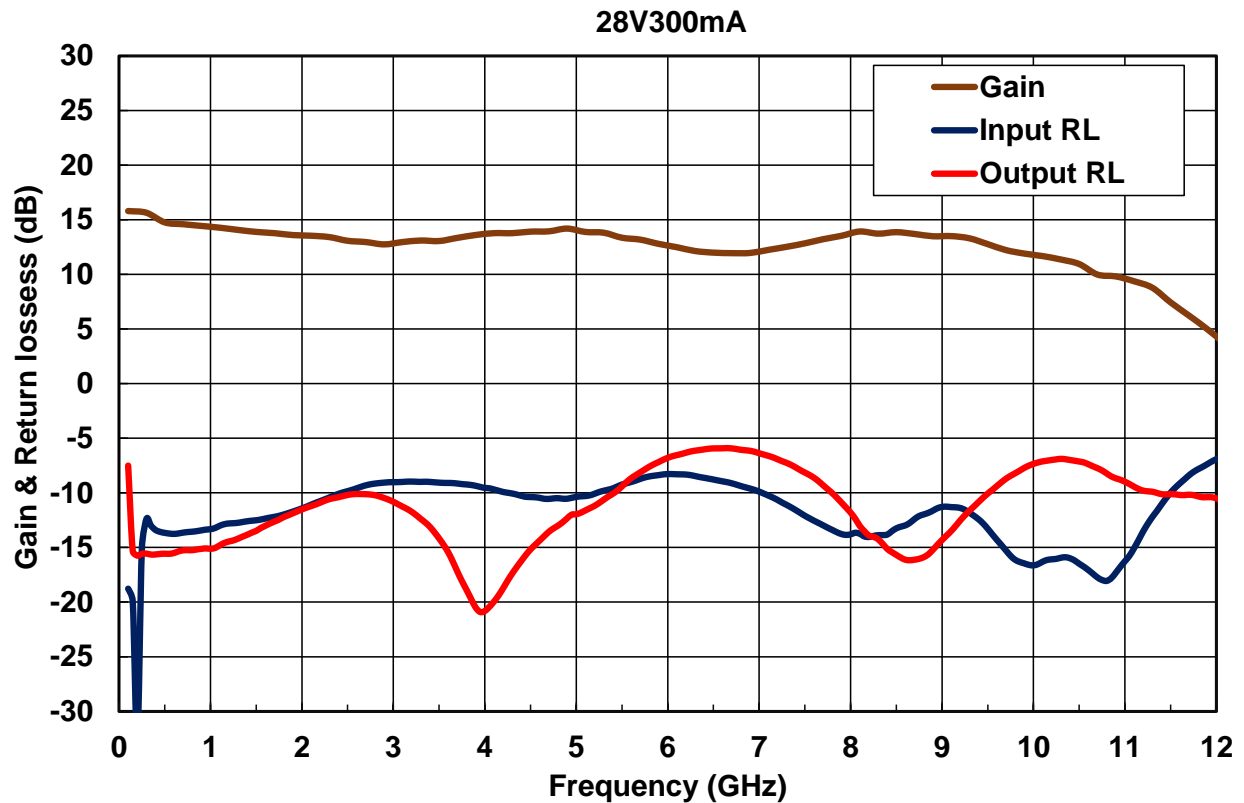
\* Specifications subject to change without notice

**ABSOLUTE MAXIMUM RATING**

Parameters	Symbol	Rating
Drain voltage	$V_{ds1}$	30V
Gate voltage	$V_{gs}$	-6V
Drain source current	$I_{dsq}$	0.4A
Continuous dissipation at 25°C	$P_t$	20W
Channel temperature	$T_{ch}$	200°C
Operating temperature	$T_{op}$	-55°C to +85°C
Storage temperature	$T_{sto}$	-55°C to +135°C

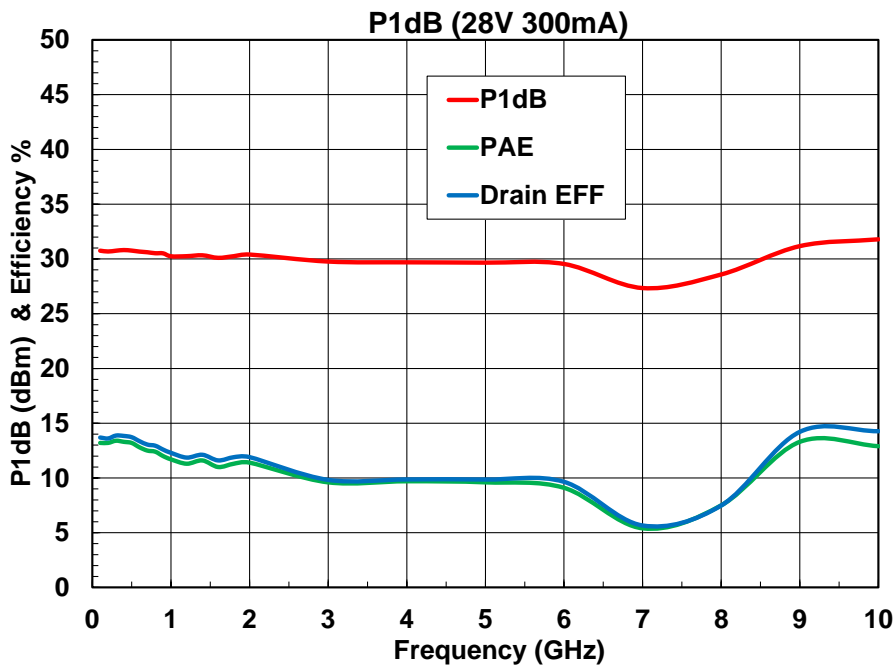
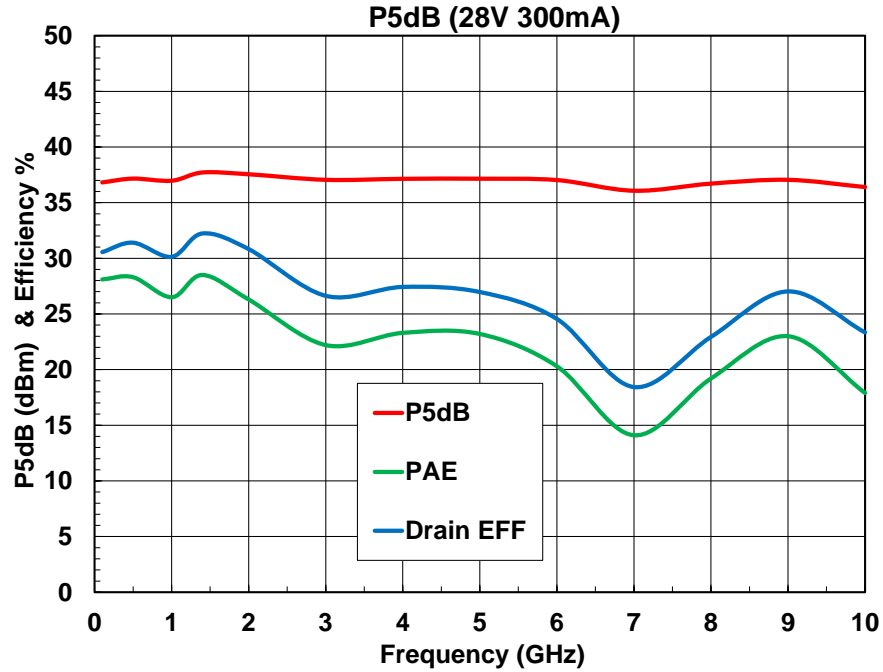
**SMALL SIGNAL DATA\***

**S-Parameters (AM00010037WN-SN-R)**



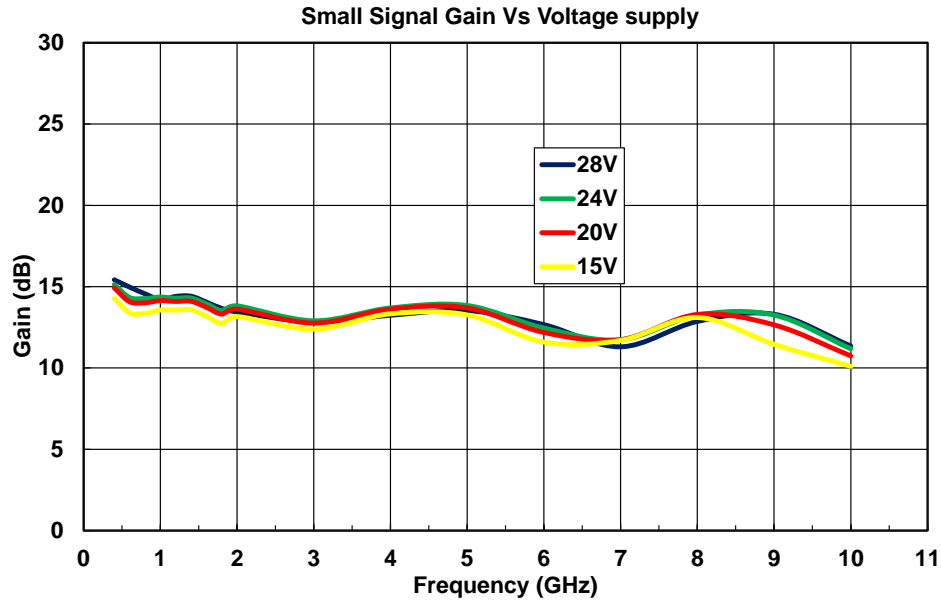
POWER DATA (Measured using Type 1 Test fixture (Shown on page 7))

A)  $V_{ds} = +28V$ ,  $I_{ds} = 0.3A$ ,  $V_{gs} = -2V$

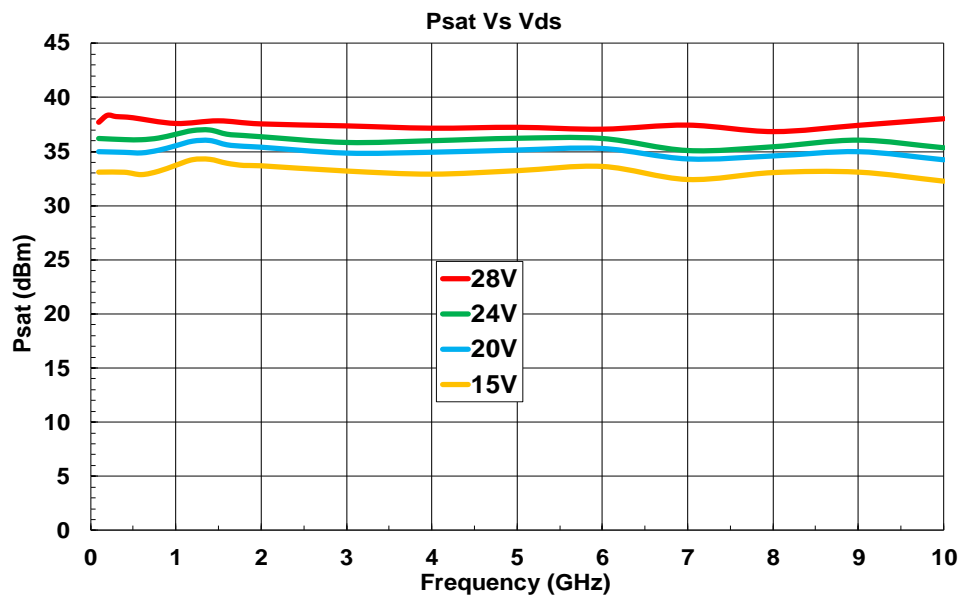


MEASUREMENT VS VOLTAGE

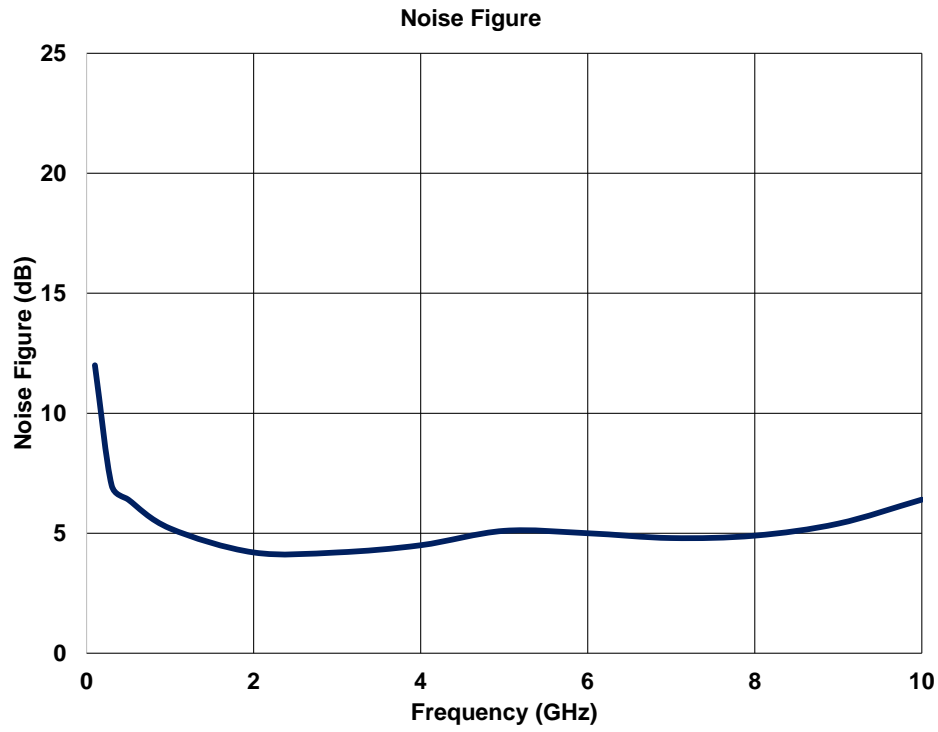
Gain Vs Voltage



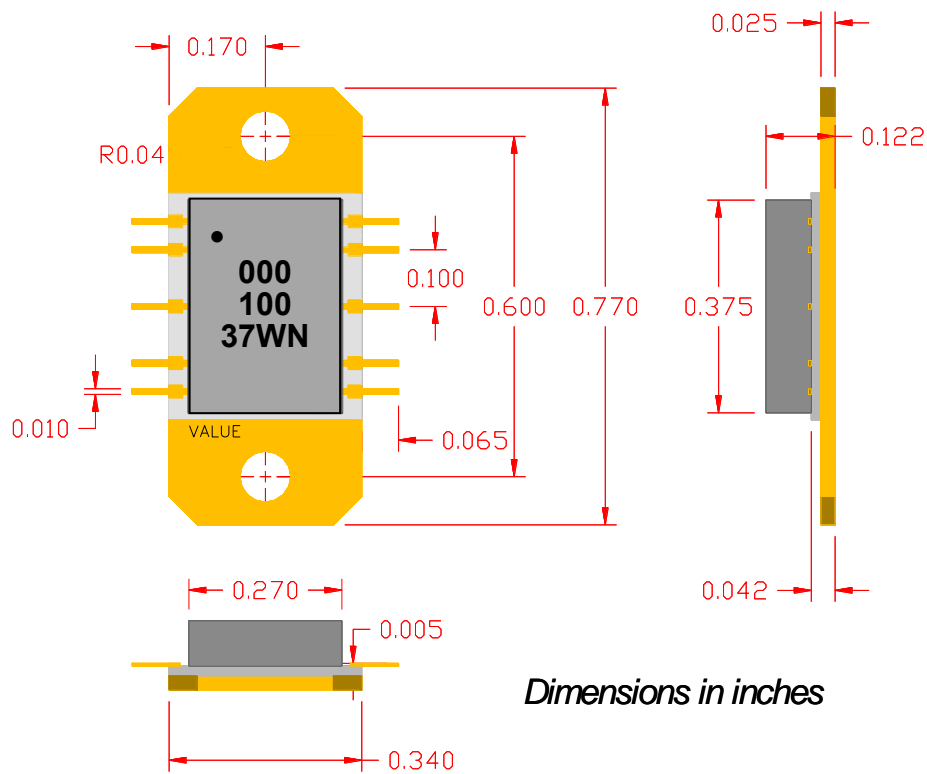
POWER VS VOLTAGE



NOISE FIGURE

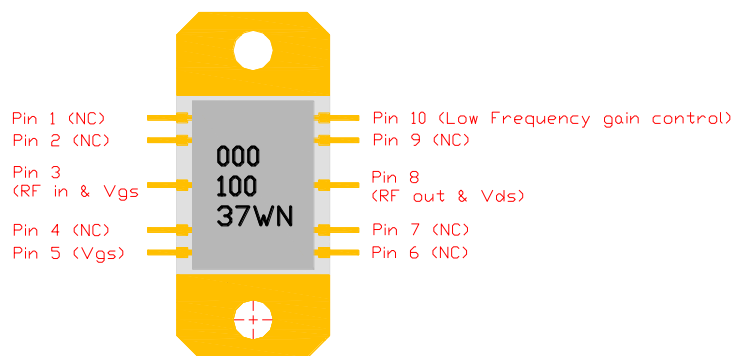


PACKAGE OUTLINE



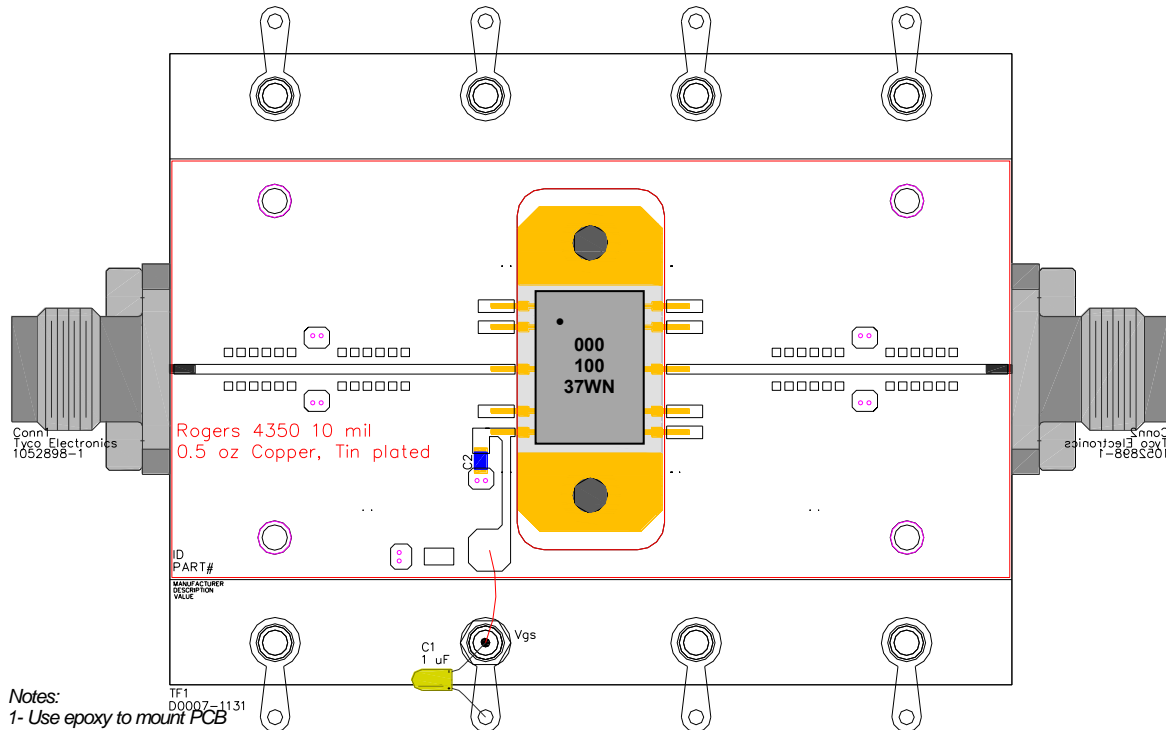
Dimensions in inches

Pin Layout



Pin No.	Function	Bias
1	NC	-
2	NC	-
3	RF in & Vgs	-2.0V
4	NC	-
5	Vgs	-2.0V
6	NC	-
7	NC	-
8	RF out & Vds	+28V
9	NC	-
10	Low frequency gain control	-

TEST CIRCUIT (Type 1)

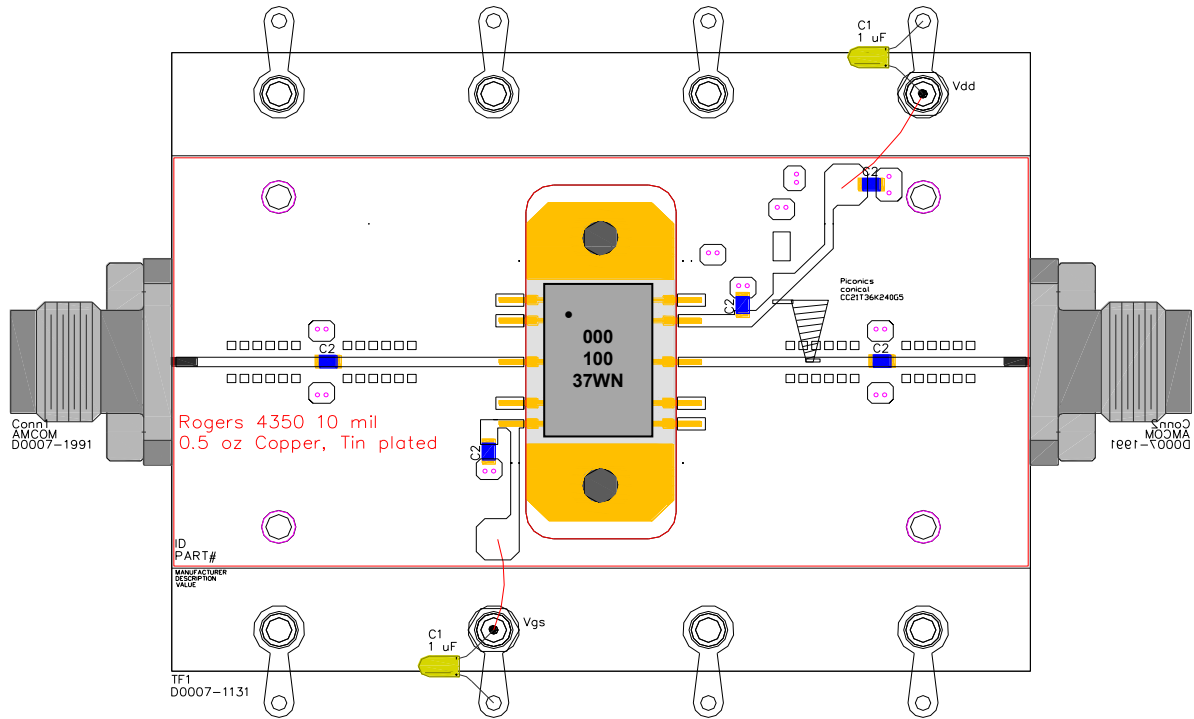


- Notes:
- 1- Use epoxy to mount PCB
  - 2- C1=1uF, C2=1000pF
  - 3- All SMT Caps & Resistors are 0603 size
  - 4- Use Test Block No. D0007-1131

Important Notes:

- 1- For best RF performance we recommend using 4mil indium shim between MMIC package and heatsink
- 2- Recommended current bias is 300mA. Gate biases of -2V is for reference only.  $V_{gs}$  could be adjusted to vary the current going thru the MMIC.
- 3- Do not apply  $V_{dd}$  without proper negative voltages on  $V_{gs}$ . Otherwise MMIC would fail due to excess heat.
- 4-  $V_{ds}$  is applied through the output RF port using bias tee and similarly  $V_{gs}$  is applied using a bias tee on the input RF port. Alternatively  $V_{gs}$  could be applied on PIN 5 as shown above.
- 5- Need to connect Bias tee to Both Input and Output RF connectors.

TEST CIRCUIT (Type 2)



- Notes:
- 1- Use epoxy to mount PCB
  - 2- C1=1uF, C2=1000pF
  - 3- All SMT Caps & Resistors are 0603 size
  - 4- Use Test Block No. D0007-1131
  - 5- Use AMCOM K-Connector P/N D0007-1991
  - 6- Use Piconics conical CC21T36K240G5

Important Notes:

- 1- For best RF performance we recommend using 4mil indium shim between MMIC package and heatsink
- 2- Recommended current bias is 300mA. Gate biases of -2V is for reference only.  $V_{gs}$  could be adjusted to vary the current going thru the MMIC.
- 3- Do not apply  $V_{dd}$  without proper negative voltages on  $V_{gs}$ . Otherwise MMIC would fail due to excess heat.
- 4-  $V_{ds}$  is applied through PIN 8 using bias tee (Conical inductor and a DC block capacitor as shown above).  $V_{gs}$  is applied on PIN 5 as shown above and DC blocking Capacitor is added.
- 5- No need to connect Bias tee to Both Input and Output RF connectors.